

FGPF7N60LSD

600V, 7A Low Saturation IGBT CO-PAK

Features

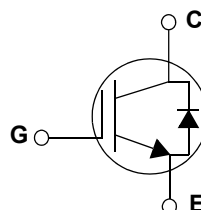
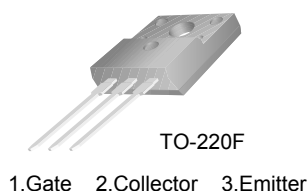
- Low saturation voltage : $V_{CE(sat)} = 1.4 \text{ V @ } I_C = 7\text{A}$
- High input impedance
- CO-PAK, IGBT with FRD : $t_{rr} = 50 \text{ ns (typ.)}$

Description

Fairchild's Insulated Gate Bipolar Transistors (IGBTs) provides very low conduction and switching losses. The device is designed for Lamp applications where very low On-Voltage Drop is a required feature.

Applications

Lamp applications (Hallogen Dimmer)



Absolute Maximum Ratings

Symbol	Description		FGPF7N60LSD	Units
V _{CES}	Collector-Emitter Voltage		600	V
V _{GES}	Gate-Emitter Voltage		± 20	V
I _C	Collector Current	@ T _C = 25°C	14	A
	Collector Current	@ T _C = 100°C	7	A
I _{CM (1)}	Pulsed Collector Current		21	A
I _F	Diode Continuous Forward Current	@ T _C = 100°C	12	A
I _{FM}	Diode Maximum Forward Current		60	A
P _D	Maximum Power Dissipation	@ T _C = 25°C	45	W
	Maximum Power Dissipation	@ T _C = 100°C	18	W
T _J	Operating Junction Temperature		-55 to +150	°C
T _{stg}	Storage Temperature Range		-55 to +150	°C
T _L	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 Seconds		300	°C

Notes :

(1) Repetitive rating : Pulse width limited by max. junction temperature

Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Units
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction-to-Case	--	2.8	$^\circ\text{C/W}$
$R_{\theta JC}$ (DIODE)	Thermal Resistance, Junction-to-Case	--	4.5	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (PCB Mount) (2)	--	62.5	$^\circ\text{C/W}$

Notes :

(2) Mounted on 1" square PCB (FR4 or G-10 Material)

Package Marking and Ordering Information

Device Marking	Device	Package	Packaging Type	Qty per Tube	Max Qty per Box
FGPF7N60LSD	FGPF7N60LSDTU	TO-220F	Rail /Tube	50ea	1,000ea

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
Off Characteristics						
BV _{CES}	Collector-Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 250uA	600	--	--	V
ΔB _{V_{CES}} /ΔT _J	Temperature Coefficient of Breakdown] Voltage	V _{GE} = 0V, I _C = 1mA	--	0.6	--	V/°C
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0V	--	--	250	uA
I _{GES}	G-E Leakage Current	V _{GE} = V _{GES} , V _{CE} = 0V	--	--	± 100	nA
On Characteristics						
V _{GE(th)}	G-E Threshold Voltage	I _C = 7mA, V _{CE} = V _{GE}	5.0	6.5	8.0	V
V _{CE(sat)}	Collector to Emitter Saturation Voltage	I _C = 7A, V _{GE} = 15V	--	1.4	2.0	V
		I _C = 7A, V _{GE} = 15V, T _C = 125°C	--	1.47	--	V
		I _C = 14 A, V _{GE} = 15V	--	1.85	--	V
Dynamic Characteristics						
C _{ies}	Input Capacitance	V _{CE} = 30V, V _{GE} = 0V, f = 1MHz	--	510	--	pF
C _{oes}	Output Capacitance		--	55	--	pF
C _{res}	Reverse Transfer Capacitance		--	15	--	pF
Switching Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V, I _C = 7A, R _G = 470Ω, V _{GE} = 15V, Inductive Load, T _C = 25°C	--	120	--	ns
t _r	Rise Time		--	44	--	ns
t _{d(off)}	Turn-Off Delay Time		--	410	535	ns
t _f	Fall Time		--	2320	3480	ns
E _{on}	Turn-On Switching Loss		--	0.27	--	uJ
E _{off}	Turn-Off Switching Loss		--	3.8	--	mJ
E _{ts}	Total Switching Loss		--	4.07	6.1	mJ
t _{d(on)}	Turn-On Delay Time	V _{CC} = 300 V, I _C = 7 A, R _G =470Ω, V _{GE} = 15V, Inductive Load, T _C = 125°C	--	105	--	ns
t _r	Rise Time		--	50	--	ns
t _{d(off)}	Turn-Off Delay Time		--	420	--	ns
t _f	Fall Time		--	3745	--	ns
E _{on}	Turn-On Switching Loss		--	0.22	--	uJ
E _{off}	Turn-Off Switching Loss		--	5.94	--	mJ
E _{ts}	Total Switching Loss		--	6.16	--	mJ
Q _g	Total Gate Charge	V _{CE} = 300 V, I _C = 7A, V _{GE} = 15V	--	24	36	nC
Q _{ge}	Gate-Emitter Charge		--	4	6	nC
Q _{gc}	Gate-Collector Charge		--	10	15	nC
L _e	Internal Emitter Inductance	Measured 5mm from PKG	--	7.5	--	nH

Electrical Characteristics of DIODE $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Units
V _{FM}	Diode Forward Voltage	I _F = 7A	T _C = 25°C	--	1.65	2.1	V
			T _C = 100°C	--	1.58	--	
t _{rr}	Diode Reverse Recovery Time	I _F = 7A dI/dt = 200 A/μs	T _C = 25°C	--	50	65	ns
			T _C = 100°C	--	58	--	
I _{rr}	Diode Peak Reverse Recovery Current		T _C = 25°C	--	2.5	3.75	A
			T _C = 100°C	--	3.3	--	
Q _{rr}	Diode Reverse Recovery Charge		T _C = 25°C	--	62.5	122	nC
			T _C = 100°C	--	95.7	--	

Typical Performance Characteristics

Figure 1. Typical Output Characteristics

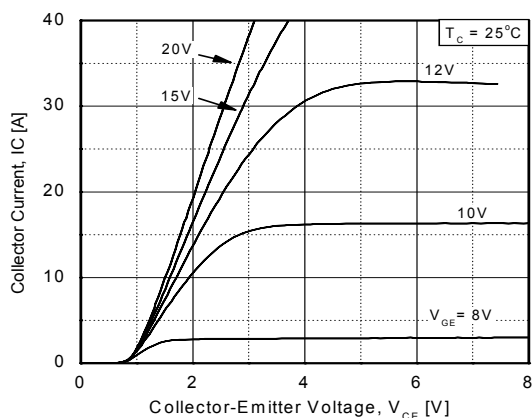


Figure 2. Typical Saturation Voltage Characteristics

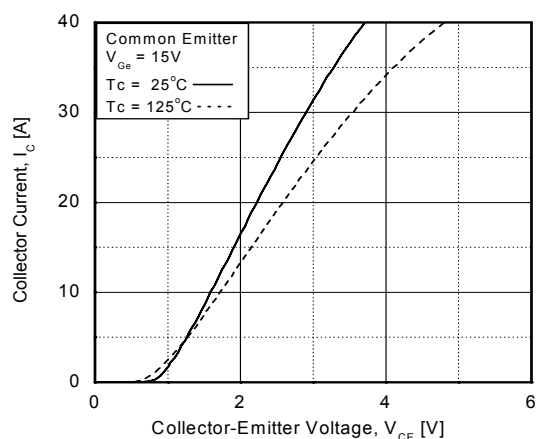


Figure 3. Typical Saturation Voltage Characteristics

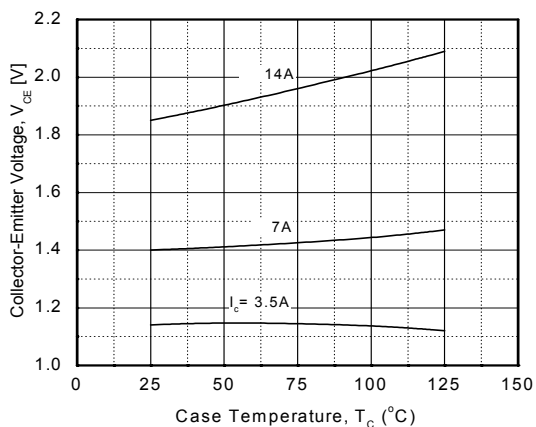


Figure 4. Load Current vs Frequency

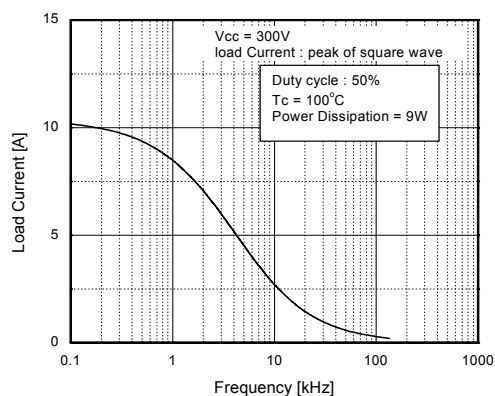


Figure 5. Saturation Voltage vs. V_{GE}

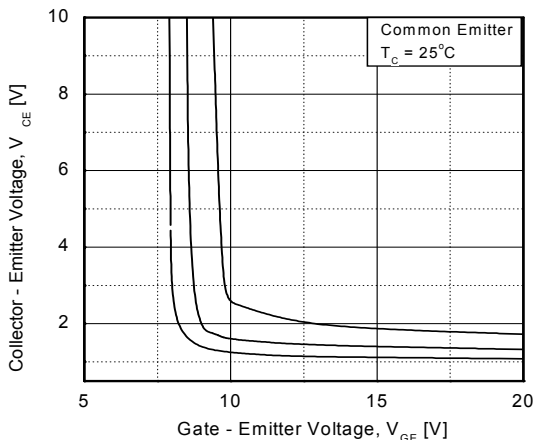
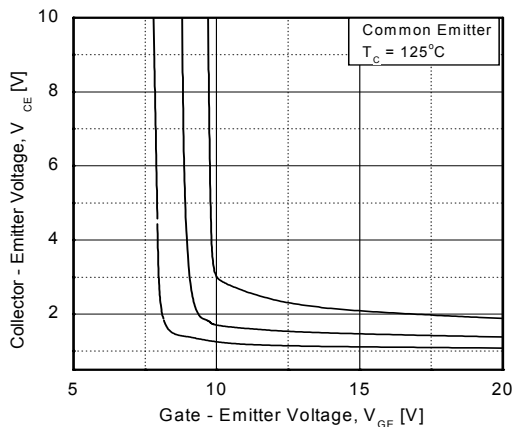


Figure 6. Saturation Voltage vs. V_{GE}



Typical Performance Characteristics (Continued)

Figure 7. Capacitance Characteristics

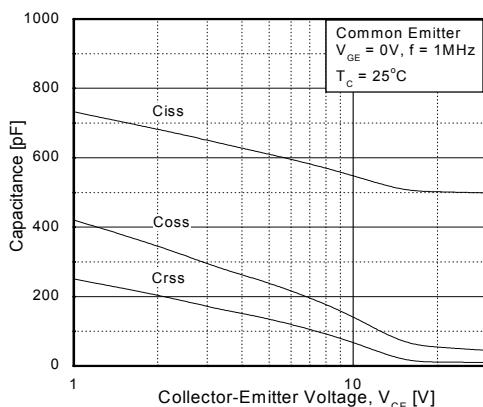


Figure 8. Turn-On Characteristics vs. Gate Resistance

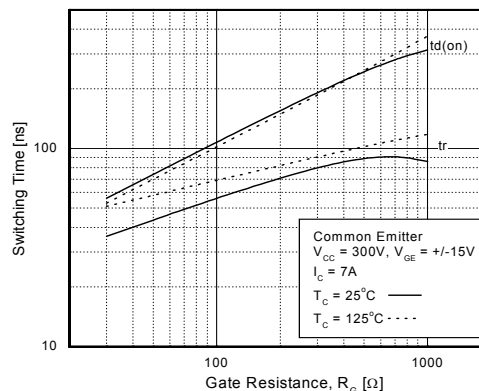


Figure 9. Turn-Off Characteristics vs. Gate Resistance

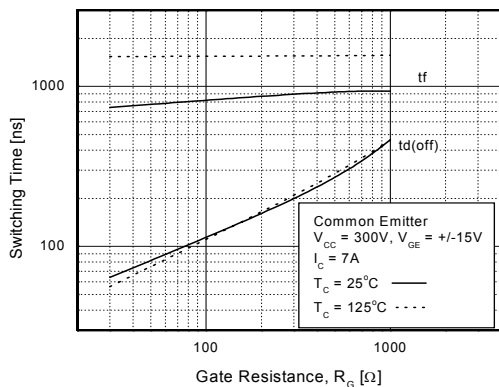


Figure 10. Switching Loss vs. Gate Resistance

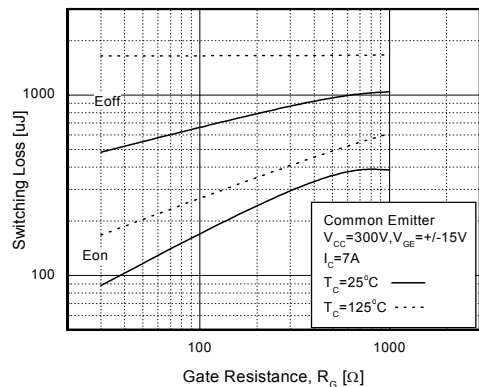


Figure 11. Turn-On Characteristics vs. Collector Current

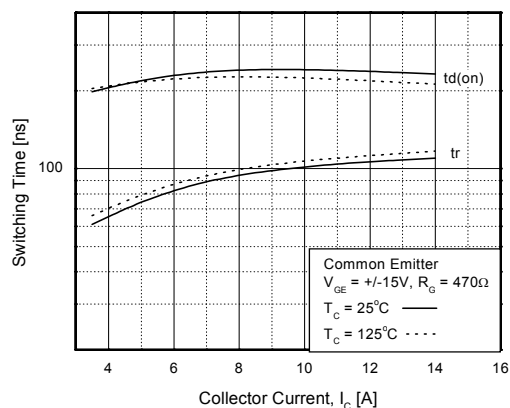
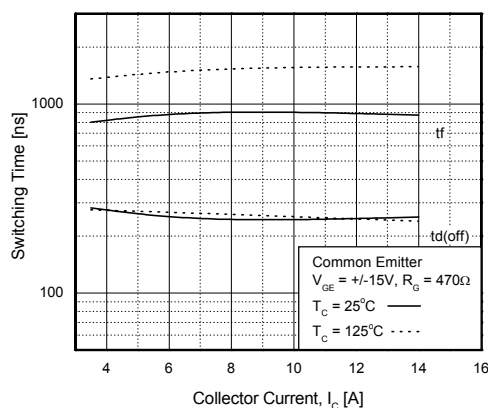


Figure 12. Turn-Off Characteristics vs. Collector Current



Typical Performance Characteristics (Continued)

Figure 13. Switching Loss vs. Collector Current

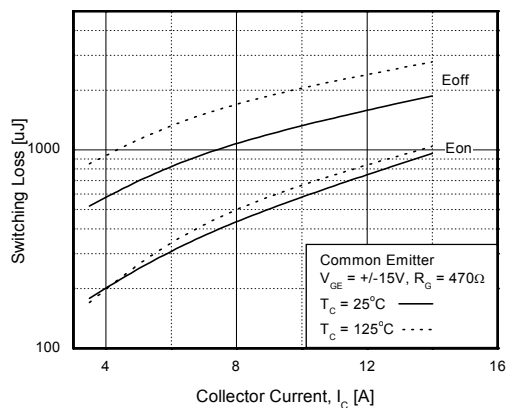


Figure 14. Gate Charge Characteristics

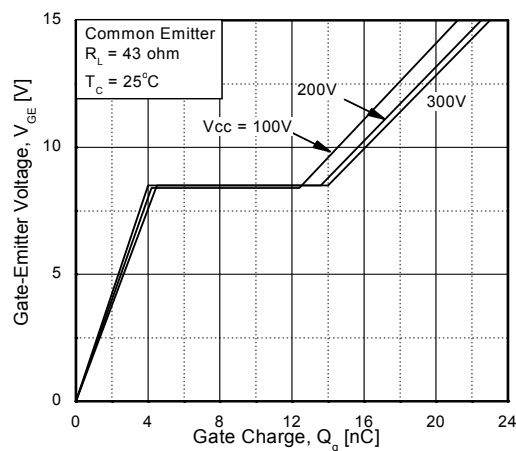


Figure 15. SOA Characteristics

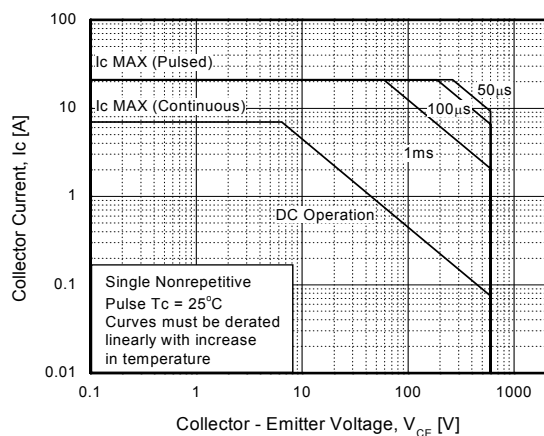
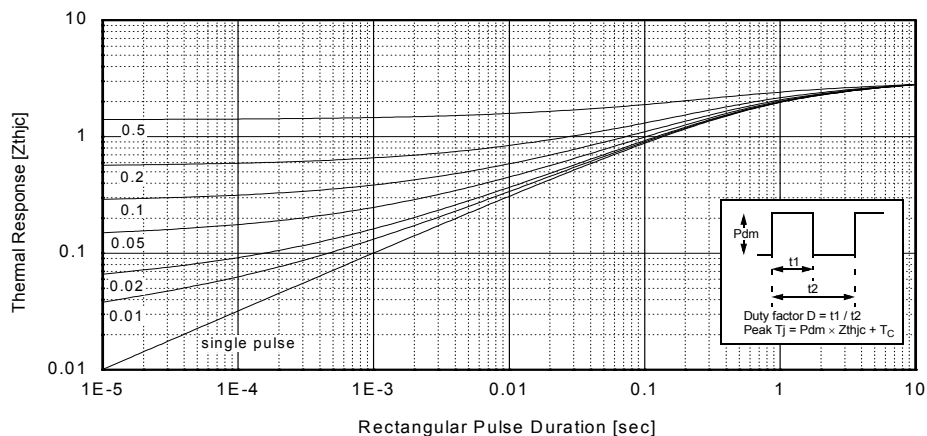


Figure 16. Transient Thermal Impedance of IGBT



Typical Performance Characteristics (Continued)

Figure 17. Forward Voltage Characteristics

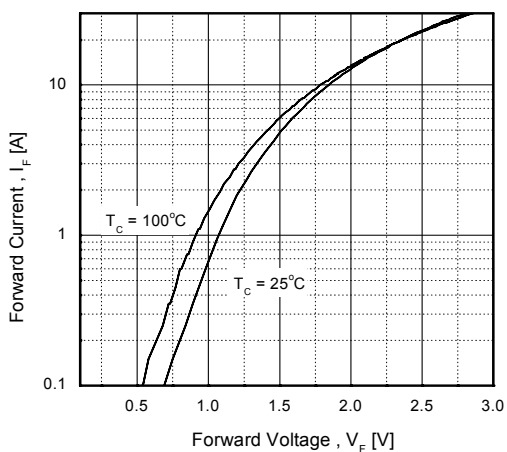


Figure 18. Reverse Recovery Current

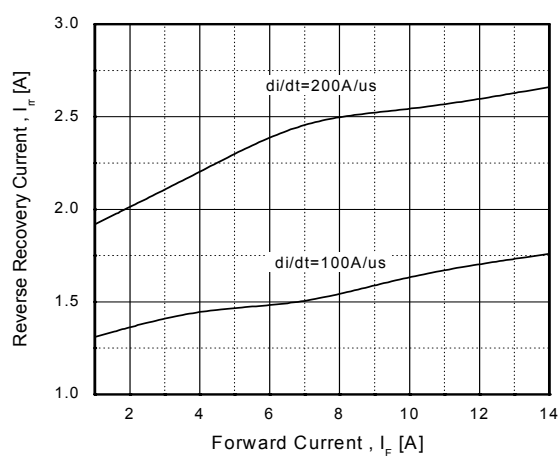


Figure 19. Stored Charge

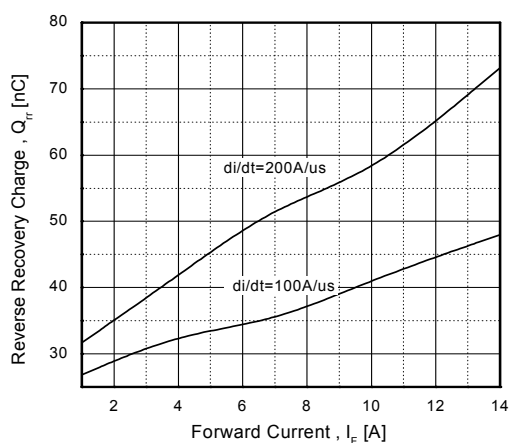
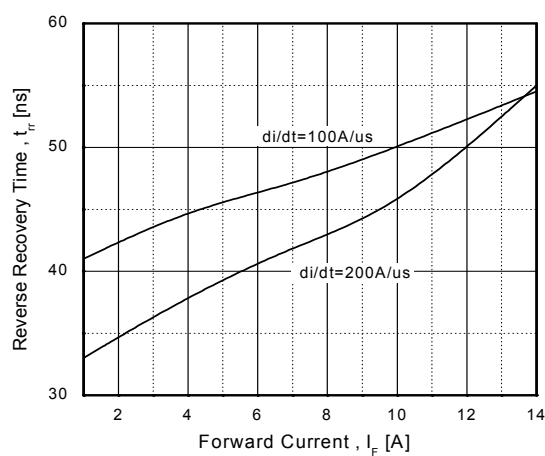
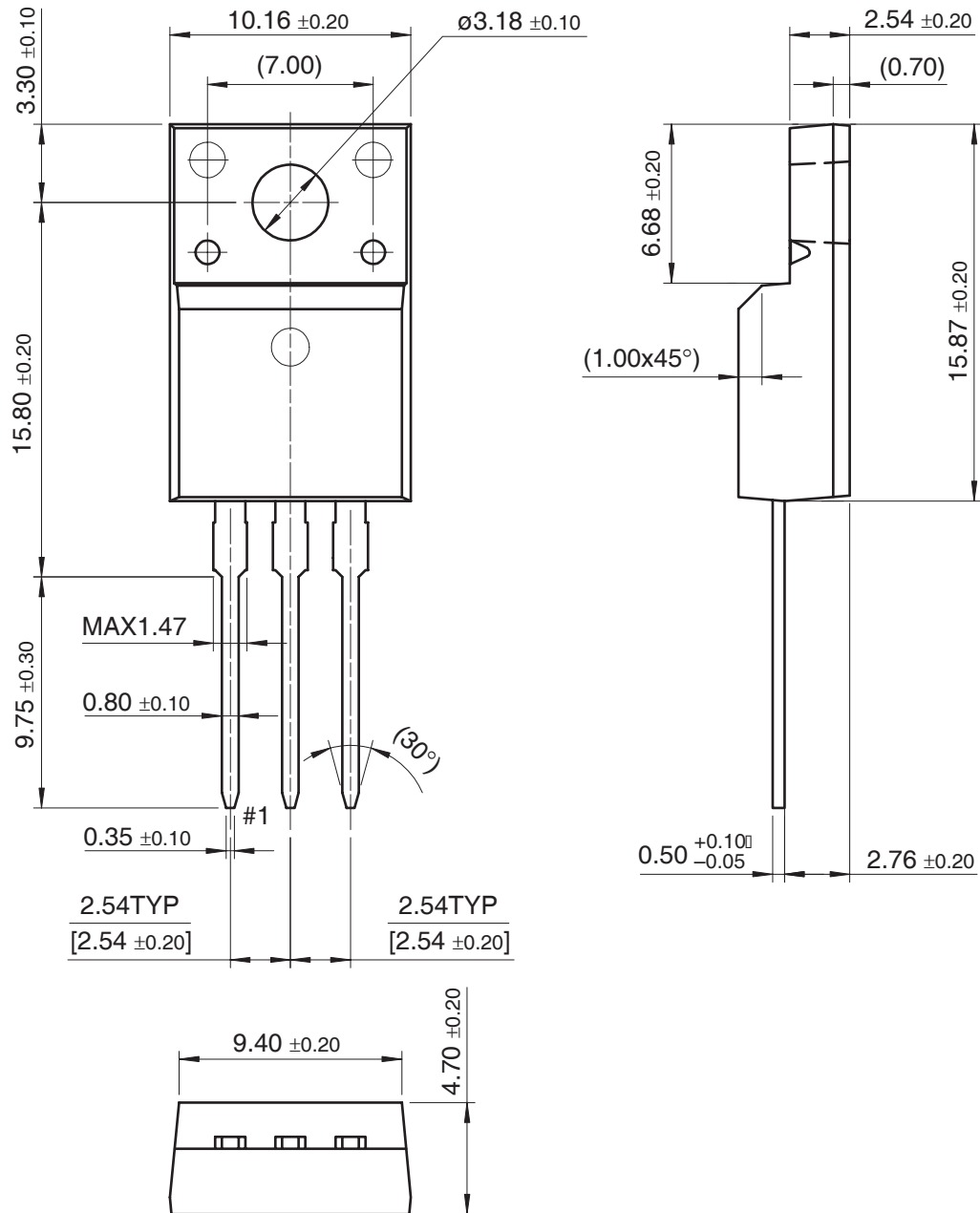


Figure 20. Reverse Recovery Time



Mechanical Dimensions

TO-220F



Dimensions in Millimeters

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Rev. I17



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